- Rugged Epitaxial Planar Construction
- 10 A Continuous Collector Current
- Operating Characteristics Fully Guaranteed at 100°C
- t_{xo} typically 320 ns, I_C = 10 A



Pin 2 is in electrical contact with the mounting base.

MDTRACA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT		
	TIPL790	N/	150		
Collector-base voltage ($I_E = 0$)	TIPL790A	V _{CBO}	200	V	
Collector emitter voltage $(1/2)$	TIPL790	M	150	V	
Collector-emitter voltage ($V_{BE} = 0$)	TIPL790A	V _{CES}	200	v	
Callester emitter voltage (I 0)	TIPL790	N/	120	V	
Collector-emitter voltage $(I_B = 0)$	TIPL790A	V _{CEO}	150	v	
Emitter-base voltage	V _{EBO}	8	V		
Continuous collector current	۱ _C	10	A		
Peak collector current (see Note 1)	I _{CM}	15	A		
Continuous device dissipation at (or below) 25°C case temperature	P _{tot}	70	W		
Operating junction temperature range	Тj	-65 to +150	°C		
Storage temperature range	T _{stg}	-65 to +150	°C		

NOTE 1: This value applies for $t_p \leq 10$ ms, duty cycle $\leq 2\%.$



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electrical characteristics at 25°C case temperature (unless otherwise noted)

I	PARAMETER			TEST CO	NDITIONS		MIN	TYP	MAX	UNIT	
.,	Collector-emitter			L = 25 mH	(see Note 2)	TIPL790	120				
V _{CEO(sus)}	sustaining voltage	I _C = 1	00 mA			TIPL790A	150			V	
V _{CBO}	Collector-base		4 4		(see Note 3)	TIPL790	150			V	
	breakdown voltage	I _C =	1 mA			TIPL790A	200			V	
		V _{CE} =	150 V	$V_{BE} = 0$		TIPL790			0.05		
	Collector-emitter	V _{CE} =	200 V	$V_{BE} = 0$		TIPL790A			0.05		
ICES	cut-off current	V _{CE} =	150 V	$V_{BE} = 0$	T _C = 100°C	TIPL790			1	mA	
		V _{CE} =	200 V	$V_{BE} = 0$	$T_{\rm C} = 100^{\circ}{\rm C}$	TIPL790A			1		
I _{CEV}	Collector cut-off current	V _{CE} =	150 V	1 5 . \/ 9 \/		TIPL790			50		
		V _{CE} =	$V_{CE} = 200 V$ 1.5 < $V_{EB} < 8 V$		TIPL790A			50	μA		
I _{CEO}	Collector cut-off	V _{CE} =	120 V	I _B = 0		TIPL790			50		
	current	V _{CE} =	150 V	$I_{B} = 0$		TIPL790A			50	μA	
I _{EBO}	Emitter cut-off current	V _{EB} =	5 V	l _C = 0					4	mA	
h _{FE}	Forward current transfer ratio	V _{CE} =	5 V	I _C = 0.5 A	(see Notes 3 ar	nd 4)	60		500		
		I _B =	20 mA	$I_{\rm C} = 4 {\rm A}$					1.2		
V	Collector-emitter	$I_B =$	30 mA	I _C = 7 A	(see Notes 3 ar	nd 4)			1.5	V	
V _{CE(sat)}	saturation voltage	$I_B =$	50 mA	I _C = 10 A					2.0	V	
		$I_B =$	50 mA	$I_{\rm C} = 10 {\rm A}$	$T_{\rm C} = 100^{\circ}{\rm C}$				2.0		
V _{BE(sat)}		I _B =	20 mA	$I_{C} = 4 A$					1.8		
	Base-emitter	$I_B =$	30 mA	I _C = 7 A	(see Notes 3 ar	nd 4)			1.9	V	
	saturation voltage	$I_B =$	50 mA	$I_{\rm C} = 10 {\rm A}$					2.2	V	
		$I_B =$	50 mA	$I_{\rm C} = 10 {\rm A}$	$T_C = 100^{\circ}C$				2.1		
V_{EC}	Parallel diode forward voltage	I _E =	10 A	I _B = 0					3	V	
f _t	Current gain bandwidth product	V _{CE} =	10 V	I _C = 0.5 A	f = 1 MHz	(see Note 5)		10		MHz	
C _{ob}	Output capacitance	V _{CB} =	20 V	I _E = 0	f = 0.1 MHz			90		pF	

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, t_{p} = 300 $\mu s,$ duty cycle $\leq 2\%.$

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

5. To obtain f_t the $[h_{FE}]$ response is extrapolated at the rate of -6 dB per octave from f = 1 MHz to the frequency at which $[h_{FE}] = 1$.

thermal characteristics

PARAMETER			TYP	MAX	UNIT
R _{θJC}	Junction to case thermal resistance			1.79	°C/W

inductive-load-switching characteristics at 25°C case temperature (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]			MIN	TYP	MAX	UNIT
t _{si}	Current storage time	I _C = 10 A I _{B(off)} = -2.5 A	I _{B(on)} = 50 mA V _{BE(off)} = -5 V	(see Figures 1 and 2)		450	700	ns
t _{rv}	Voltage rise time					160	750	ns
t _{fi}	Current fall time					250	400	ns
t _{ti}	Current tail time					280	450	ns
t _{xo}	Cross over time					320	500	ns

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

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PARAMETER MEASUREMENT INFORMATION





NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15$ ns, $R_{in} > 10 \Omega$, $C_{in} < 11.5$ pF. B. Resistors must be noninductive types.





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MAXIMUM SAFE OPERATING REGIONS



Figure 7.



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MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



B. Mounting tab corner profile according to package version.

C. Typical fixing hole centre stand off height according to package version.

Version 1, 18.0 mm. Version 2, 17.6 mm.

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